

RZ/A2M Group

R01AN4395EG0100

Rev.1.0

RZ/A2M GPIO Driver

Sept 25, 2018

Introduction

This application note describes the operation of the software GPIO driver for the RZ/A2 device on the RZ/A2M CPU board.

It provides a comprehensive overview of the driver. For further details please refer to the software driver itself.

The user is assumed to have knowledge of e² studio and to be equipped with an RZ/A2M CPU board.

Target Device

RZ/A2M Group

Driver Dependencies

This driver depends on:

- Drivers
 - o STDIO

Referenced Documents

Document Type	Document Name	Document No.
User's Manual	RZ/A2M Hardware Manual	R01UH0746EJ

List of Abbreviations and Acronyms

Abbreviation	Full Form
ANSI	American National Standards Institute
GPIO	General Purpose Input Output
HLD	High Layer / Level Driver
LLD	Low Layer / Level Driver
MCU	Microcontroller Unit
OS	Operating System
PDR	Port Direction Register
PFS	Pin Function Control (Select) Register
PIDR	Port Input Data Register
PMR	Port Mode Register
PODR	Port Output Data Register
RTOS	Real Time Operating System
STDIO	Standard Input / Output

Table 1-1 List of Abbreviations and Acronyms

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1. Outline of the GPIO Driver

This MCU provides a total of 22 sets of dedicated port pins and general-purpose input/output port pins P0 to PL, and JP00 and JP01. Each pin is also configurable as an I/O pin of a peripheral module or an input pin for an interrupt. All pins are set to nonuse immediately after a reset (Hi-Z input protection), and pin functions can be switched by register settings.

The general-purpose input/output port pins are multiplexed with the peripheral on-chip module functions. The functions multiplexed on these pins can be selected as desired by setting of the registers.

Each port has the port direction register (PDR) that selects non-use, input, or output, the port output data register (PODR) that holds data for output, the port input register (PIDR) that indicates the pin states, and the port mode register (PMR) that specifies the pin function of each port.

Each port has the control register (PFS) that is used to select the input/output function and interrupt pin from the multiplexed port pins, and to assign the function to the selected pin.

For further information regarding the hardware specifics of the GPIO peripheral please refer to the appropriate hardware manual.

The GPIO driver provides a layer of abstraction between these registers and the user application, allowing for simplified porting of the application to a different device.

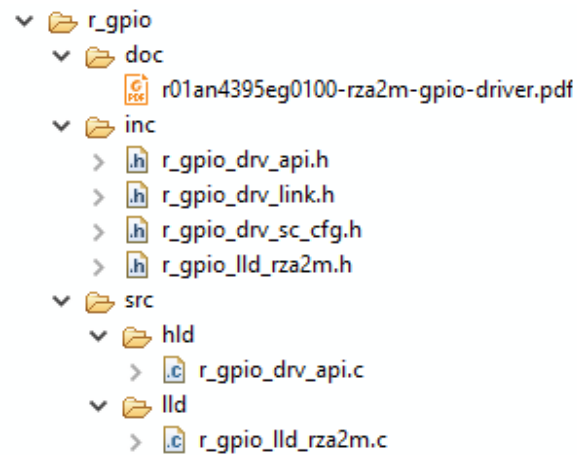
2. Description of the Software Driver

The key features of the driver include:

- Allocating individual pin function to GPIO or peripheral
- Setting GPIO pin to input / output / or Hi-Z (not used)
- Configuring GPIO pin to generate interrupts
- Writing the logic level on an output pin
- Reading the logic level of an input pin
- Setting the peripheral function for a pin allocated to a peripheral

2.1 Structure

The GPIO driver is split into two parts: The High Layer Driver (HLD) and the Low Layer Driver (LLD). The HLD includes platform independent features of the driver, implemented via the STDIO standard functions. The LLD includes all the hardware specific functions.



2.2 Description of each file

Each file's description can be seen in the following table.

Filename	Usage	Description
Application-Facing Driver API		
r_gpio_drv_api.h	Application	The only API header file to include in application code
High Layer Driver (HLD) Source		
r_gpio_drv_api.c	Private (HLD only)	High Layer Driver (HLD) source code implementing the driver API functions
Abstraction Link between High and Low Layer Drivers (HLD/LLD Link)		
r_gpio_drv_link.h	Private (HLD/LLD only)	Header file intended as an abstraction between low and high layers. This header will include the device specific configuration file "r_gpio_lld_rza2m.h"
Low Layer Driver (LLD) Source		
r_gpio_lld_rza2m.c	Private (LLD only)	Provides the implementation of the Low Layer Driver interface
r_gpio_lld_rza2m.h	Private (LLD only)	Low Layer Driver header file. Provides the High Layer Driver with access to the LLD driver functions
Smart Configurator		
r_gpio_drv_sc_cfg.h	Private (HLD/LLD only)	This file is intended to be used by Smart Configurator to pass setup information to the driver. This is not for application use

2.3 High Level Driver

The High Layer Driver can be either used through STDIO or through direct access. It is recommended not to mix both access methods.

The driver layer functions can be seen in the below table:

Return Type	Function	Description	Arguments	Return
int_t	gpio_hld_open (st_stream_ptr_t p_stream)	Driver initialisation interface is mapped to open function called directly using the st_r_driver_t GPIO driver handle g_gpio_driver: i.e. g_gpio_driver.open()	[in] p_stream driver handle.	DRV_SUCCESS Open Success DRV_ERROR Open Error
void	gpio_hld_close (st_stream_ptr_t p_stream)	Driver close interface is mapped to close function called directly using the st_r_driver_t GPIO driver structure g_gpio_driver: i.e. g_gpio_driver.close()	[in] p_stream driver handle.	None
int_t	gpio_hld_read (st_stream_ptr_t p_stream, uint8_t *p_buffer, uint32_t count)	Driver close interface is mapped to read function called directly using the st_r_driver_t GPIO driver structure g_gpio_driver: i.e. g_gpio_driver.read()	[in] p_stream driver handle. [out] p_buffer buffer for returned data. [in] count size of buffer.	Amount of Data Read DRV_ERROR Write Error
int_t	gpio_hld_write (st_stream_ptr_t p_stream, uint8_t *p_buffer, uint32_t count)	Driver write interface is mapped to write function called directly using the st_r_driver_t GPIO driver structure g_gpio_driver: i.e. g_gpio_driver.write()	[in] p_stream driver handle. [in] p_buffer data to send. [in] count size of data to send.	DRV_SUCCESS Write Success DRV_ERROR Write Error
int_t	gpio_hld_control (st_stream_ptr_t p_stream, uint32_t ctl_code, void* p_ctl_struct)	Driver control interface function Maps to ANSI library low level control function called directly using the st_r_driver_t GPIO driver structure g_gpio_driver: i.e. g_gpio_driver.control()	[in] p_stream driver handle. [in] ctl_code the type of control function to use. [in/out] p_ctl_struct required parameter is dependent upon the control function.	DRV_SUCCESS Operation Success DRV_ERROR Operation Error

Return Type	Function	Description	Arguments	Return
int_t	gpio_get_version (st_stream_ptr_t p_stream, st_ver_info_ptr_t p_ver_info)	Driver get_version interface function maps to extended non-ANSI library low level get_version function called directly using the st_r_driver_t GPIO driver structure g_gpio_driver: i.e. g_gpio_driver.get_version()	[in] p_stream handle to the (pre-opened) channel. [out] p_ver_info handle to the (pre-opened) channel.	DRV_SUCCESS Operation Success

These high layer functions can be accessed either executed directly or through STDIO.

2.4 Low Layer Driver

The Low Layer Driver provides the functions to configure the hardware.

Return Type	Function	Description	Arguments	Return
<code>e_r_drv_gpio_err_t</code>	R_GPIO_HWInitialise (void)	Initialises the GPIO hardware	None	GPIO_SUCCESS
<code>e_r_drv_gpio_err_t</code>	R_GPIO_HWUninitialise (void)	Uninitialises the GPIO hardware	None	GPIO_SUCCESS
<code>e_r_drv_gpio_err_t</code>	R_GPIO_PinSetConfiguration (const <code>st_r_drv_gpio_sc_config_t</code> * <code>p_config</code>)	Set single pin configuration	p_config [in] configuration data	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
<code>e_r_drv_gpio_err_t</code>	R_GPIO_PinGetConfiguration (<code>st_r_drv_gpio_sc_config_t</code> * <code>p_config</code>)	Get single pin configuration	p_config [out] configuration data	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
<code>e_r_drv_gpio_err_t</code>	R_GPIO_InitByPinList (const <code>r_gpio_port_pin_t</code> * <code>p_pin_list</code> , <code>uint32_t</code> count)	Set pin configuration by a pin list and marks the pins as in use. The configuration is retrieved from the Smart Configurator table	p_pin_list [in] the pins to initialise count [in] the number of pins in the list	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
<code>e_r_drv_gpio_err_t</code>	R_GPIO_ClearByPinList (const <code>r_gpio_port_pin_t</code> * <code>p_pin_list</code> , <code>uint32_t</code> count)	Clear pins by a pin list and mark the pins as not in use	p_pin_list [in] the pins to clear count [in] the number of pins in the list	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
<code>e_r_drv_gpio_err_t</code>	R_GPIO_InitByTable (const <code>st_r_drv_gpio_sc_config_t</code> * <code>p_table</code> , <code>uint32_t</code> count)	Configures pins from an array of pin configurations and marks the pins as in use	p_table [in] array of pin configuration data count [in] number of pins in the array	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
<code>e_r_drv_gpio_err_t</code>	R_GPIO_ClearByTable (const <code>st_r_drv_gpio_sc_config_t</code> * <code>p_table</code> , <code>uint32_t</code> count)	Clears pins from an array of pin configurations and marks the pins as not in use	p_table [in] array of pin configuration data count [in] number of pins in the array	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
<code>e_r_drv_gpio_err_t</code>	R_GPIO_PortWrite (<code>r_gpio_port_t</code> port, <code>uint8_t</code> value)	Sets the logic levels on the specified port	port [in] the port to write to value [in] the value to write	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure

Return Type	Function	Description	Arguments	Return
e_r_drv_gpio_err_t	R_GPIO_PortRead (r_gpio_port_t port, uint8_t * value)	Reads the logic levels on the specified port	port [in] the port to read from value [out] receives the value read from the port	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
e_r_drv_gpio_err_t	R_GPIO_PortDirectionSet (r_gpio_port_t port, e_r_drv_gpio_dir_t dir, uint8_t mask)	Sets the direction on specified pins of the port	port [in] the port to set dir [in] the direction to set mask [in] specifies which bits to set	This function is not yet implemented and returns GPIO_ERR_INVALID_CFG
e_r_drv_gpio_err_t	R_GPIO_PinWrite (r_gpio_port_pin_t pin, e_r_drv_gpio_level_t level)	Sets the logic level on the specified pin	pin [in] the port / pin to set level [in] the logic level to set it to	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
e_r_drv_gpio_err_t	R_GPIO_PinRead (r_gpio_port_pin_t pin, e_r_drv_gpio_level_t * level)	Gets the logic level on the specified pin	pin [in] the port / pin to read level [out] the logic level read from the pin	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
e_r_drv_gpio_err_t	R_GPIO_PinDirectionSet (r_gpio_port_pin_t pin, e_r_drv_gpio_dir_t dir)	Sets the direction on the specified pin (input, output or Hi-Z)	pin [in] the port / pin to set dir [in] the direction to set	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
e_r_drv_gpio_err_t	R_GPIO_PinDirectionGet (r_gpio_port_pin_t pin, e_r_drv_gpio_dir_t * dir)	Gets the direction on the specified pin (input, output or Hi-Z)	port_pin [in] the port / pin to read dir [out] receives the direction currently set	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
e_r_drv_gpio_err_t	R_GPIO_PinAssignmentSet (r_gpio_port_pin_t pin, e_r_drv_gpio_assign_t assignment)	Assigns a pin to GPIO or to a peripheral	pin [in] the port / pin to assign assignment [in] how to assign the pin (GPIO or peripheral)	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
e_r_drv_gpio_err_t	R_GPIO_PinAssignmentGet (r_gpio_port_pin_t pin, e_r_drv_gpio_assign_t * p_assignment)	Determines whether a pin is assigned to GPIO or a peripheral	pin [in] the port / pin to read assignment [out] how the pin is assigned (GPIO or peripheral)	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure

Return Type	Function	Description	Arguments	Return
e_r_drv_gpio_err_t	R_GPIO_PinTintSet (r_gpio_port_pin_t pin, e_r_drv_gpio_tint_t tint)	Turns interrupts on or off for a pin	pin [in] the port / pin to set tint [in] whether to enable or disable interrupts	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
e_r_drv_gpio_err_t	R_GPIO_PinTintGet (r_gpio_port_pin_t pin, e_r_drv_gpio_tint_t * p_tint)	Reads interrupt on / off setting for a pin	pin [in] the port / pin to get the interrupts for p_tint [out] the interrupt setting	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
e_r_drv_gpio_err_t	R_GPIO_PinDscrSet (r_gpio_port_pin_t pin, e_r_drv_gpio_current_t current)	Sets pin DSCR current (4mA or 8mA)	pin [in] the port / pin to set the DSCR for current [in] the current to set	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
e_r_drv_gpio_err_t	R_GPIO_PinDscrGet (r_gpio_port_pin_t pin, e_r_drv_gpio_current_t * p_current)	Gets pin DSCR current setting (4mA or 8mA)	pin [in] the port / pin to get the DSCR for current [out] the current to set	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
e_r_drv_gpio_err_t	R_GPIO_PeripheralFunctionWrite (r_gpio_port_pin_t pin, uint8_t psel)	Sets the peripheral function for a pin	pin [in] the port / pin to set psel [in] the code for the required peripheral function	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
e_r_drv_gpio_err_t	R_GPIO_PeripheralFunctionRead (r_gpio_port_pin_t pin, uint8_t * p_psel)	Gets the peripheral function setting for a pin	pin [in] the port / pin to get psel [out] the code for the current peripheral function setting	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
e_r_drv_gpio_err_t	R_GPIO_PinSetFunction (r_gpio_port_pin_t pin, e_r_drv_gpio_function_t function)	Set the function of the specified pin	pin [in] the port / pin to set function [in] the function to set it to	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
e_r_drv_gpio_err_t	R_GPIO_PinGetFunction (r_gpio_port_pin_t pin, e_r_drv_gpio_function_t * p_function)	Get the function of the specified pin	pin [in] the port / pin to get function [out] the current function setting	GPIO_SUCCESS on success or a GPIO_ERR_X error code on failure
e_r_drv_gpio_err_t	R_GPIO_GetVersion (st_drv_info_t * pinfo)	Get the version information of the low level driver	pinfo [out] Receives the version information	DRV_SUCCESS: Success DRV_ERROR: Error

3. Accessing the High Layer Driver

3.1 STDIO

The HLD's API can be accessed through the ANSI 'C' library <stdio.h>. The following table details the operation of each function:

Operation	Return	Function Details
open	gs_stdio_handle, unique handle to driver	open (DEVICE_IDENTIFIER "gpio", O_RDWR);
close	DRV_SUCCESS successful operation, or driver specific error	close (gs_stdio_handle);
read	Number of characters read, -1 on error	read (gs_stdio_handle, buff, data_length);
write	Number of characters written, -1 on error	write (gs_stdio_handle, buff, data_length);
control	DRV_SUCCESS control was process, or driver specific error	control (gs_stdio_handle, CTRL, &struct);
get_version	DRV_SUCCESS drv_info was updated, or DRV_ERROR drv_info was not updated	get_version (DEVICE_IDENTIFIER "gpio", &drv_info);

3.2 Direct

The following table shows the available direct functions.

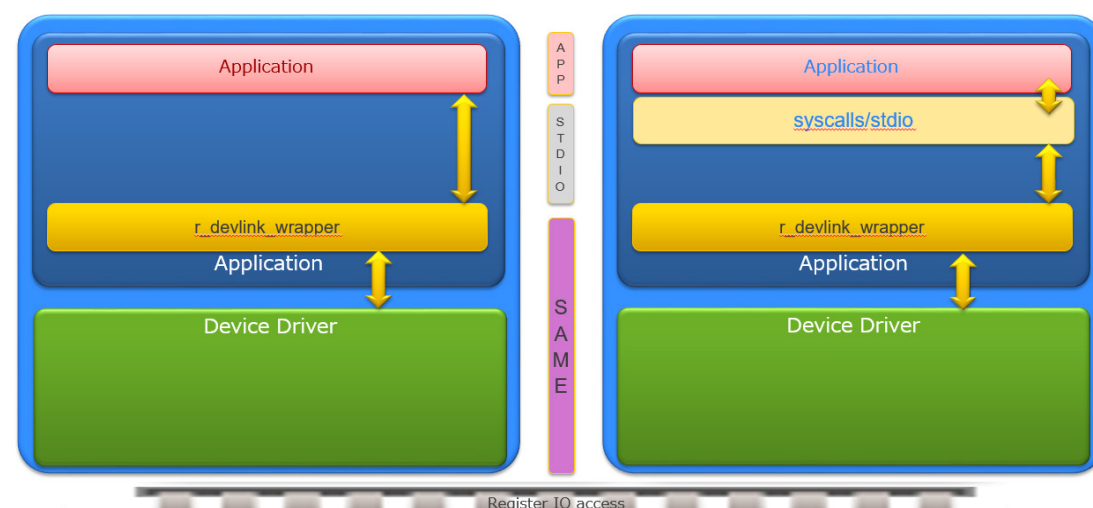
Operation	Return	Function details
open	gs_direct_handle unique handle to driver	direct_open ("gpio", 0);
close	DRV_SUCCESS successful operation, or driver specific error	direct_close (gs_direct_handle);
read	Number of characters read, -1 on error	direct_read (gs_direct_handle, buff, data_length);
write	Number of characters written, -1 on error	direct_write (gs_direct_handle, buff, data_length);
control	DRV_SUCCESS control was process, or driver specific error	direct_control (gs_direct_handle, CTRL, &struct);
get_version	DRV_SUCCESS drv_info was updated, or DRV_ERROR drv_info was not updated	direct_get_version ("gpio", &drv_info);

3.3 Comparison

The diagram below illustrates the difference between the direct and ANSI STDIO methods.

Direct

ANSI STDIO



4. Example of Use

This section illustrates a simple example of opening the driver, configuring a port, writing to a pin, reading from a pin, and then closing the driver.

4.1 Open

```
int_t gs_gpio_handle;  
char_t *driver_name = "gpio";  
  
gs_gpio_handle = open(driver_name, O_RDWR);
```

4.2 Control – Set Configuration Settings

```
st_r_drv_gpio_config_t pin_configuration;  
int_t result;  
  
pin_configuration.config.pin = GPIO_PORT_0_PIN_2;  
pin_configuration.config.configuration.function = GPIO_FUNC_OUT;  
pin_configuration.config.configuration.tint = GPIO_TINT_DISABLE;  
pin_configuration.config.configuration.current = GPIO_CURRENT_8mA;  
  
result = control(handle, CTL_GPIO_SET_CONFIGURATION,  
                (void *) &pin_configuration);
```

4.3 Control – Get Configuration Settings

```
st_r_drv_gpio_config_t pin_configuration;  
int_t result;  
  
result = control(handle, CTL_GPIO_GET_CONFIGURATION,  
                (void *) &pin_configuration);
```

4.4 Write the Logic Level to a Pin

```
st_r_drv_gpio_pin_rw_t pin_read_write;  
int_t result;  
  
pin_read_write.pin = GPIO_PORT_0_PIN_6;  
pin_read_write.level = GPIO_LEVEL_HIGH;  
result = control(handle, CTL_GPIO_PIN_WRITE,  
                (void *) &pin_read_write);
```

4.5 Read the Logic Level from a Pin

```
st_r_drv_gpio_pin_rw_t pin_read_write;  
e_r_drv_gpio_level_t logic_level;  
int_t result;  
  
pin_read_write.pin = GPIO_PORT_0_PIN_6;  
result = control(handle, CTL_GPIO_PIN_READ,  
                (void *) &pin_read_write);  
  
logic_level = pin_read_write.level;
```

4.6 Close

```
close(gs_gpio_handle);
```

4.7 Get Version

```
st_ver_info_t info;  
result = get_version(gs_gpio_handle, &info);
```

5. OS Support

This driver supports any OS through using the OS Abstraction module. For more details about the abstraction module please refer to the OS abstraction module application note.

6. How to Import the Driver

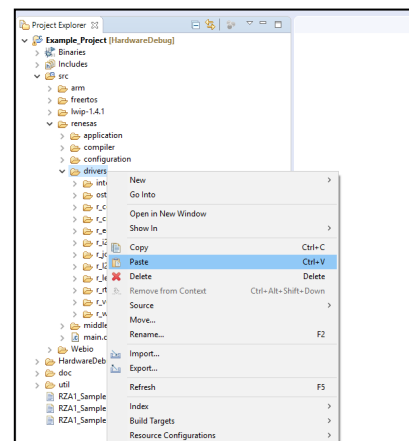
This section describes how to import the driver into your project. Generally, there are two steps in any IDE:

- 1) Copy the `r_gpio` driver to the location in the source tree that you require for your project.
- 2) Add the link to where you copied your driver to the compiler.

6.1 e² studio

To import the driver into your project please follow the instructions below.

- 1) In Windows Explorer, right-click on the `r_gpio` folder, and click **Copy**.
- 2) In e² studio Project Explorer view, select the folder where you wish the driver project to be located; right-click and click **Paste**.
- 3) Right-click on the parent project folder (in this case 'Example_Project') and click **Properties ...**
- 4) In 'C/C++ Build → Settings → Cross ARM Compiler → Includes', add the include folder of the newly added driver, e.g. `'${ProjDirPath}\generate\drivers\r_gpio\inc'`



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Revision History

Rev.	Date	Description	
		Page	Summary
1.00	Sept 25, 2018	All	Created document.

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Handling of Unused Pins

Handle unused pins in accordance with the directions given under Handling of Unused Pins in the manual.

- ¾ The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible. Unused pins should be handled as described under Handling of Unused Pins in the manual.

2. Processing at Power-on

The state of the product is undefined at the moment when power is supplied.

- ¾ The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the moment when power is supplied.
In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the moment when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the moment when power is supplied until the power reaches the level at which resetting has been specified.

3. Prohibition of Access to Reserved Addresses

Access to reserved addresses is prohibited.

- ¾ The reserved addresses are provided for the possible future expansion of functions. Do not access these addresses; the correct operation of LSI is not guaranteed if they are accessed.

4. Clock Signals

After applying a reset, only release the reset line after the operating clock signal has become stable. When switching the clock signal during program execution, wait until the target clock signal has stabilized.

- ¾ When the clock signal is generated with an external resonator (or from an external oscillator) during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Moreover, when switching to a clock signal produced with an external resonator (or by an external oscillator) while program execution is in progress, wait until the target clock signal is stable.

5. Differences between Products

Before changing from one product to another, i.e. to a product with a different part number, confirm that the change will not lead to problems.

- ¾ The characteristics of Microprocessing unit or Microcontroller unit products in the same group but having a different part number may differ in terms of the internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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